

## Article

# Analysis of Reconstruction Energy Efficiency in EIT and ECT 3D Tomography Based on Elastic Net

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**Abstract:** The main goal of this paper is to research and analyze the problem of image reconstruction performance using machine learning methods in 3D electrical capacitance tomography (ECT) and electrical impedance tomography (EIT) by comparing the areas inside the tank to determine the finite elements for which one of the method reconstructions is more effective. The research was conducted on 5000 simulated cases, which ranged from one to five inclusions generated for a cylindrical tank. The authors first used the elastic net learning method to perform the reconstruction and then proposed a method for testing the effectiveness of reconstruction. Based on this approach, the reconstructions obtained by each method were compared, and the areas within the object were identified. Finally, the results obtained from the simulation tests were verified on real measurements made with two types of tomographs. It was found that areas closer to the edge of the tank were more effectively reconstructed by EIT, while ECT reconstructed areas closer to the center of the tank. Extensive analysis of the inclusions makes it possible to use this measurement for energy optimization of industrial processes and biogas plant operation.



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## 1. Introduction

Tomography is often used for energy optimization of industrial and technological processes. It is also used in monitoring for the detection and prevention of accidents. Due to the ability to reconstruct the interior of objects using measurements only at the boundary of the object, tomography provides a non-invasive method of controlling the flow of liquids or gases in pipes. It can also be used to control the formation of crystals or gas bubbles in industrial reactors. The advantage of tomography is primarily its non-invasiveness. The presence of detectors or sensors inside the controlled object can disrupt the control of processes by invasive methods. Such a measurement can not only interfere with the production process but can also be subject to error due to the interference associated with the invasiveness of the method. Tomography has been used to control processes in industrial reactors [1,2], control the flow of liquids or gases in pipes [3,4], detect moisture in building walls [5,6], flood embankments leaks [7,8], monitor health [9,10], etc.

Advanced measurement techniques and modern IT tools [11–15] allow the monitoring of processes in real-time, providing the possibility of dynamic control of the processes and rapid diagnosis of defects. Measuring devices for industrial tomography are constantly being developed and are subject to the focus of scientific research [16–19].

The best-known tomographic method is computed tomography (CT) in medical applications. However, in recent years, the trend of industrial tomography has grown due to the development of technology.

Electrical impedance tomography is a non-invasive tomographic method used in industry and medicine. Reconstruction of the interior of the test object is carried out by measuring the voltage between electrodes placed on its edge [20]. Electrical capacitance tomography is a technique that allows spatial visualization of the interior of the examined object. Reconstruction is based on measurements of the mutual capacitance of electrodes placed on the surface of the test object [3,19,21–24]. Electrical resistivity tomography (ERT) is a technique that allows imaging using electrical resistivity measurements taken at the surface or through electrodes in one or more holes, such as in soil [7,25,26]. In addition to the mentioned types of tomography, there are several tomography methods using physical phenomena such as X-ray [27], sound waves [28], magnetism [29], etc.

The inverse problem is solved using deterministic or machine learning methods in computed tomography. Deterministic methods include the Total Variation Method [30] and Gauss-Newton with Tikhonov penalization [31]. Machine learning methods include neural networks [32], elastic net [33], logistic regression [4], etc. A comparison of the reconstruction quality using different methods can be found in the work [34,35].

Currently, there are two trends in the development of medical computed tomography. First is expanding databases and improving machine-learning algorithms to optimize automatic-disease detection and classification of tomographic images [36–39]. Second is the improvement in diagnostic tools such as microwave tomography [40,41], ultrasound tomography (UST) [42,43], and electrical tomography [44–46].

There are also two trends being actively developed in industrial tomography. First, on reconstruction algorithms in tomography based on neural networks, convolutional neural networks and machine learning algorithms [47–50] are being optimized. Others being EIT [51,52], ECT [14,53,54], or hybrid tomography devices that are being developed [54–56].

The quality of reconstruction in computed tomography depends on many factors. For example, the number of measuring electrodes, the tools used to solve the inverse problem, or the type of tomography used. When comparing the types of tomography with each other, it turns out hybrid methods often do not improve image reconstruction. In the article [56] in which the authors compare imaging with UST and EIT, both methods' image reconstruction quality was examined. It was found that for a method using simultaneous measurements from both types of tomography, the algorithm used the averages of measurements from both methods. As a result, worse results are obtained for some images rather than those using only one method.

The motivation for undertaking the research included in the paper was to see which areas inside the object under study are reconstructed better by a particular tomography method. Since reconstructing images in hybrid tomography based on a combined observation matrix often yields worse reconstructions than individual methods [56], this paper examines how electrical tomography methods reconstruct individual areas inside the tank.

The main difference of measurement in tomographs is not only the physical phenomenon that is used in tomography, i.e., the way the interior of the reconstructed object is exciting, but also the way the signal propagating inside is measured. The physics of the phenomenon usually forces the method of measurement. The variation in the reconstruction quality inside the object depends on the electric field propagating inside the object between the transmitting and receiving electrodes. In addition, the mechanism of energy dissipation of the electric field caused by the presence of inclusions, which interfere with the propagation of the signal, has a payoff. The reconstruction capability will depend on the magnitude of the conversion of electric field energy to thermal energy (absorption), and the arrangement of the measuring electrodes. Therefore, the study was conducted for two types of 3D tomography. The comparison was made on simulation data, where the elastic net machine learning algorithm was used to solve the inverse problem. The paper [52] made comparisons of machine-learning algorithms used in reconstruction with EIT. Comparisons were made between ANNs, convolutional networks, support vector machine, and elastic net. It was found that convolutional networks are the best among

the algorithms (giving the best reconstruction quality). On the other hand, the elastic net algorithm gave worse reconstructions but good quality.

This paper aims to determine the sensitivity areas of ECT and EIT in order to develop a hybrid method for image reconstruction. First, these areas are determined based on the parameter proposed in the paper. Then, the results obtained from simulation data were verified on real measurements and reconstructions.

#### Similar Research

In [56], authors explored the area of hybrid tomography for measuring humidity in the walls using capacitance and impedance tomography. The most significant difference is that no machine-learning method was used in the paper, and the authors did not study the sensitivity areas of the methods.

In contrast to the cheap method presented in the paper, it is also worth noting that hybrid tomography that describes electrical properties (permittivity and conductivity) was studied in [57] with magnetic resonance. The problem with this method is that it is not easily scalable; it is also expensive in industrial applications.

The paper by Wang [58] explored the topic of hybrid electrical capacitance and resistance tomography. The study was focused on moisture-content detection by these two techniques. This work was performed with deterministic methods using only eight electrodes.

In the paper [59], the authors used a method that combines neural networks with restricted Boltzmann machine (RBM) autoencoder in electromagnetic tomography technology (EMT) to reconstruct images. The proposed algorithm was compared with Landweber's iterative algorithm and local binary prescription algorithms for solving the inverse problem, and better reconstruction results were obtained concerning inter correlation coefficient (ICC), among others. At the same time, it was noted that the method learns better on more extensive and diverse sets.

In [60], the authors summarized the most current and evolving reconstruction algorithms in EIT tomography. Linear algorithms such as the paper present a new method for accurate reconstruction of the region of interest (ROI) based on regular wavelets iterative reconstruction procedure. Non-linear algorithms such as D-bar (low-pass filtering on the Fourier decomposition) and its improvements with CNNs while pointing out its limitations in application to 3D imaging or sparse Bayesian learning algorithms based on structural sparsity of the conductivity distribution was used. The authors compare the algorithms with each other pointing out their advantages and disadvantages but do not compare the algorithms on datasets.

The paper [61] compared LSTM and CNN machine-learning algorithms for reconstructing moisture inside the walls. It was obtained that the reconstruction algorithm using LSTM proved to be more efficient in terms of reconstruction than CNN in half of the cases.

In the paper [62], super-resolution methodology techniques were considered to improve the quality of the obtained images. It was observed that the super-resolution algorithm improves the quality of image reconstruction in EIT tomography.

The paper [63] compares radial basis neural networks (RBNN) and Hopfield neural networks (HNN) reconstruction algorithms for EIT tomography. Furthermore, these neural networks are compared with the Gauss-Newton (GN) algorithm. As a result of the comparison, it was obtained that concerning the MSE criterion, RBNN and HNN over the GN algorithm had better reconstruction quality.

The paper [64] proposes a reconstruction approach using autoencoders and deep self-training neural networks. The reconstruction method was designed by approximating sinograms using a set of randomly weighted neural networks (extreme learning machines) from potential electrical data. The system was trained on simulated images and compared with the method without autoencoders.

In [65], authors compared two ANN neural network architectures based on LeNet, the other feed-forward fully connected ANN. The comparison was based on simulated data and obtained better reconstruction quality for LeNet architecture.

The paper [66] proposed a method for optimizing machine learning algorithms in complex pixel-oriented ensemble method (POE) reconstruction. For each pixel, the reconstruction was performed with one of the algorithms elastic net, linear regression with the least-squares learner (LR-LS), linear regression with SVM learner (LR-SVM), and artificial neural networks (ANN); then, the reconstructions were optimized by selecting the best algorithms for each area. For the highest number of pixels, ANN was selected as the best algorithm, and in second place was elastic net, LR-LS, and LR-SVM.

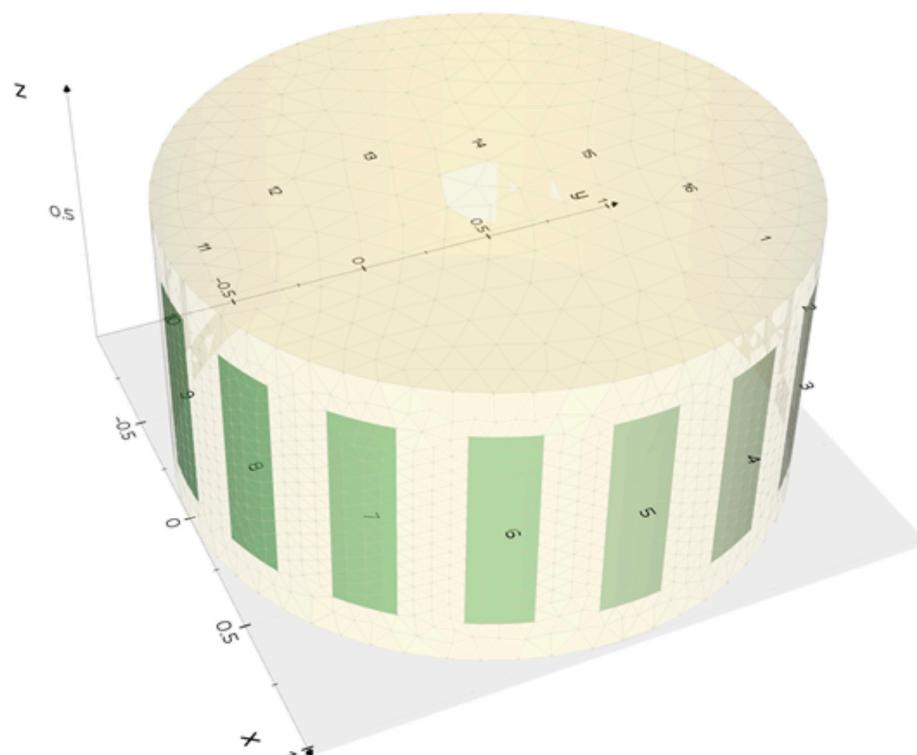
The paper [67] proposed a two-stage reconstruction learning process. The proposed method consists of a pre-construction block and a convolutional neural network (CNN). First, the pre-construction block learns the regularization pattern from the training data set and provides an approximate reconstruction of the target. The CNN then processes the results of the initial reconstruction and eliminates modeling errors due to prior information about the shape of the observation domain.

## 2. Materials and Methods

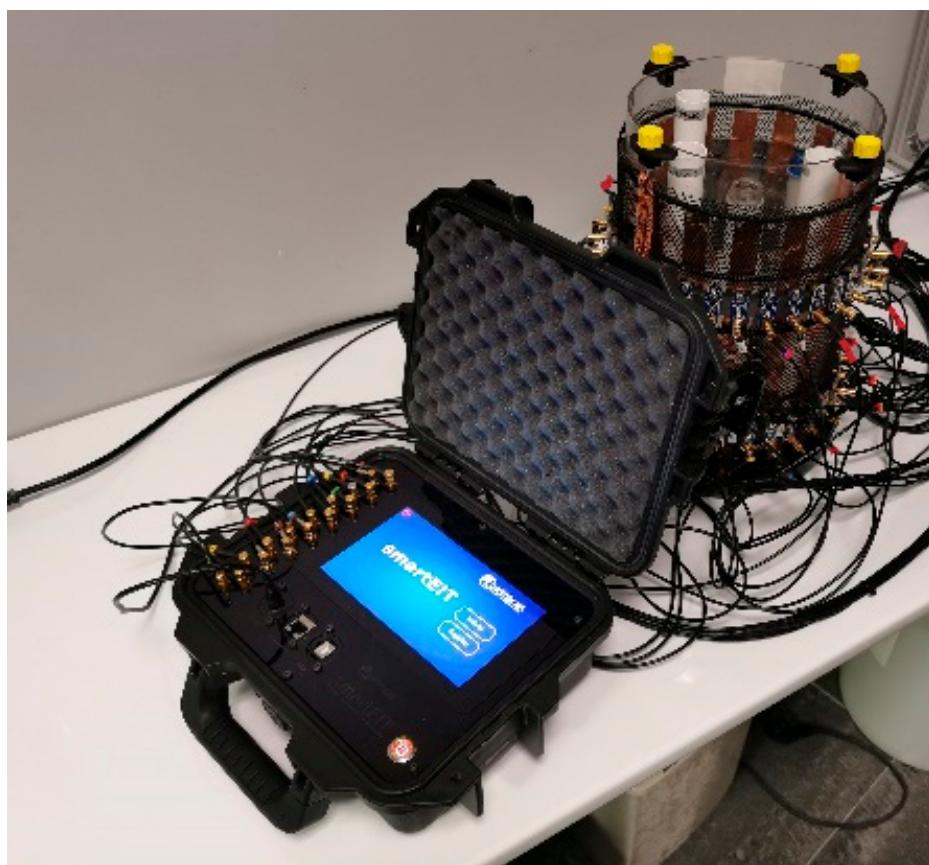
The study was performed using electrical impedance tomograph (EIT) and electrical capacitance tomograph (ECT). With each device, we measured the test objects (inclusions) in a cylindrical tank to gather real data to validate the algorithms.

### 2.1. Simulation Data and Real Measurements

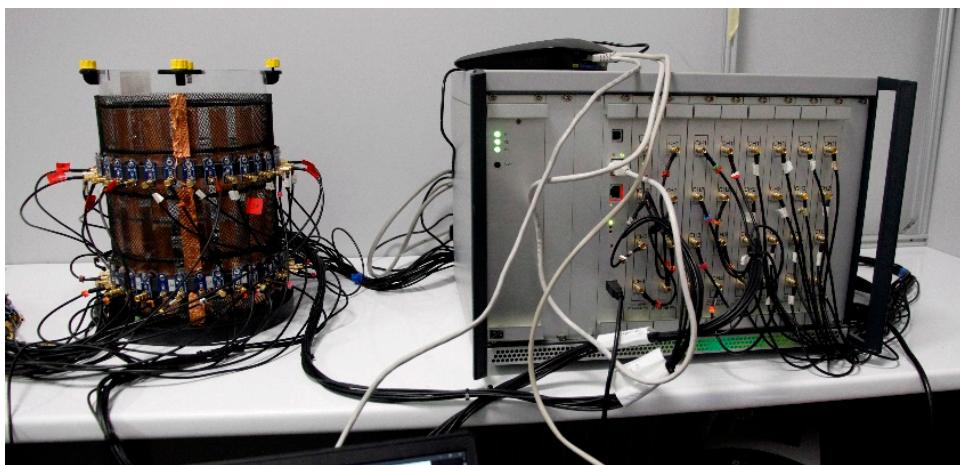
The study involved 5000 simulations of inclusions in a cylindrical pipe divided into 20,455 finite elements. The inclusions varied in diameter and were randomly distributed. Simulation data for both the electrical tomography methods were designed for a tank with 16 electrodes of each measurement type. The interior of the object was divided into 20,445 finite elements with 4837 nodes. ECT electrodes are superficial, while EIT electrodes are point electrodes. Figure 1 shows the simulation of an empty tank. The size of the simulated tank corresponded to the actual dimensions of the reconstruction tank and has dimensions of 320 mm in height and 200 mm in diameter (Figures 2 and 3).



**Figure 1.** Simulation of an empty tank for the electrical tomography methods.



**Figure 2.** Electrical impedance tomograph connected to the test tank.



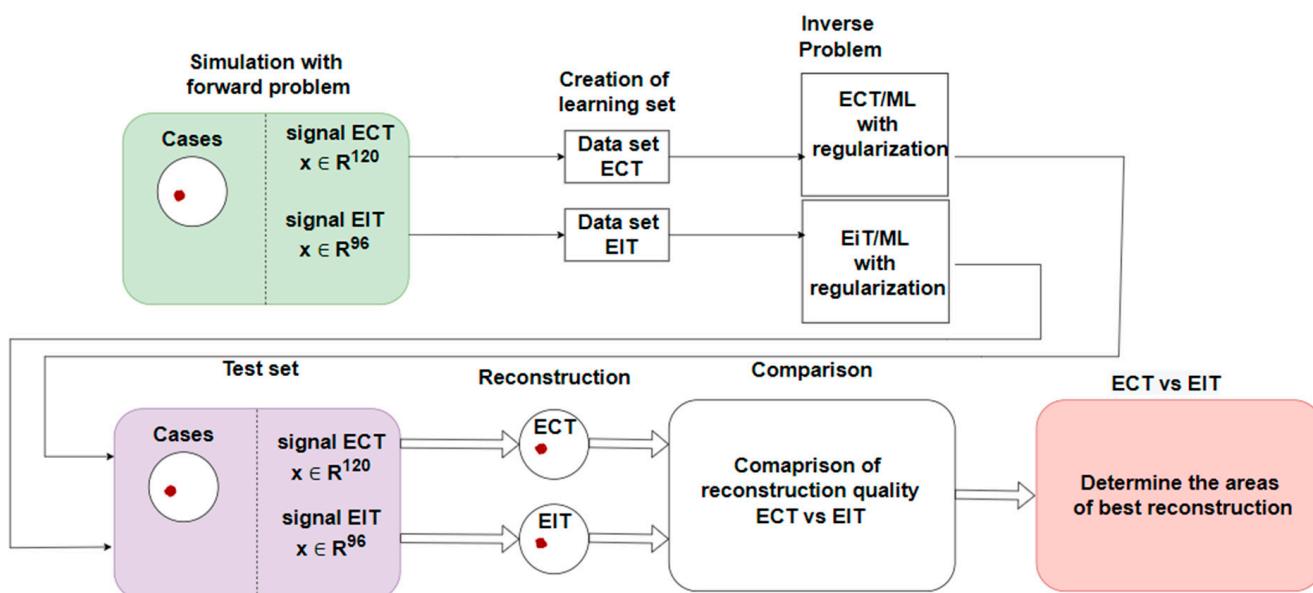
**Figure 3.** Electrical capacitance tomograph connected to the test tank.

For reconstruction, the sample was divided into two parts. The learning and testing sets contain 2000 and 3000 cases, respectively (Figure 4).

Every 5000 simulated cases are obtained by inserting one to five inclusions into the tank. In each case, the potential difference between each pair of electrodes for EIT and the capacitance measurement for ECT are obtained by solving a forward problem. The simulations were calibrated based on actual measurement data taken with the electrical impedance tomography (Figure 2) and the electrical capacitance tomography (Figure 3).

### 2.1.1. EIT Measuring Device

The SmartEIT (Figure 2) is an electrical impedance tomography measurement device. This device uses a set of graphite, point-sensing electrodes connected using SMB-electrode coaxial cables. The control and communication system is based on a Raspberry Pi 4 model B single-board minicomputer with a dedicated 7" LCD touchscreen display with  $800 \times 480$  resolution. The measurement board is equipped with a separate microcontroller from the STM32 family, based on a high-performance ARM® Cortex®-M4 32-bit core, operating at up to 72 MHz, equipped with 256 KB of flash memory, and 32 kB of RAM [14]. A key component of the data acquisition module is a set of built-in high-resolution analog-to-digital converters with software-controlled gain.



**Figure 4.** Simulation and comparison block diagram for electrical tomography methods.

In addition, the module has several analog signal conditioning systems, multiplexers switching current and voltage paths, and an isolated dual inverter that boosts the voltage supplying the analog circuits. Since the current source uses the entire range of the supplied voltage, it is possible to obtain a constant current value for objects with relatively high impedance. The input signal is a sinusoidal waveform with a fixed frequency and a constant current value. An additional expansion board is attached to the module via the FPC connector, which enables the electrodes to be connected via coaxial cables. The device is equipped with 16 SMB sockets for connecting the wires and connecting the device to the electrodes.

### 2.1.2. ECT EVT4

The ECT EVT4 (Figure 3) measurement device [54] is built on high-speed programmable circuits. The multi-mode channel system can use from 4 to 32 channels. Due to the many channels and high signal-to-noise ratio (SNR), it can be used for precise 3D measurements. Each channel has an analog-to-digital converter and multi-gigabit serial transmission for high data throughput, making dynamic imaging possible. In addition, the device utilizes a new capacitance measurement method with its novel single-shot high-voltage (SSHV) circuit.

Together with the distributed control logic architecture, this provides the device with very fast sample conversion times. Furthermore, the tomograph is controlled with proprietary software enabling the user to set measurement parameters, gain ratios, SSHV method timings, and many other settings. Moreover, it can be matched to various capacitive sensors, allowing easy measurements over a wide range along with high speed.

## 2.2. ElasticNet Method for Image Reconstruction

Reconstructions for both methods were carried out using the elastic net machine-learning method. Elastic net is a regression-based method of parameter estimation in a linear model  $Y = X\beta + \varepsilon$ , where,  $Y \in R^n$ —dependent variable,  $X \in R^{n \times k}$ —observation matrix  $Y$ —independent variable,  $n$ —number of observation,  $k$ —no. of the dependent variable,  $\beta \in R^n$ —parameter vector of the linear model, and  $\varepsilon \in R^n$ —error vector. The objective function in a linear model is defined as follows:

$$\min_{\beta} \|\varepsilon\| = \min_{\beta} \|Y - \beta X\| \quad (1)$$

$\|\cdot\|$ —Euclidean norm. Classical regression models assume that matrix  $X^T X$ —is reversible (i.e.,  $\det(X^T X) \neq 0$ ). The optimal solution is then

$$\hat{\beta} = (X^T X)^{-1} X^T Y \quad (2)$$

When the dependent variables are excessively correlated with each other, the determinant  $\det(X^T X)$  is close to zero. It disallows the correct estimation of linear model parameters.

Penalization is then used to control the variance of the  $\beta$  estimator. It is realized by adding a penalty factor to the objective function:

$$\min_{\beta} \frac{1}{2n} \sum_{i=1}^n (Y - X\beta)^2 + \theta [ (1 - \alpha) \|\beta'\|_{L_2}^2 + \alpha \|\beta'\|_{L_1} ], \quad (3)$$

where,  $x = (x_1, \dots, x_n)$   $\|x\|_{L_1} = \sum_{i=1}^n |x_i|$ , and  $\|x\|_{L_2}^2 = \sum_{i=1}^n x_i^2$ . This penalization is a linear combination of norms in space  $L_1$  and  $L_2$ , where, the parameter  $\alpha \in [0, 1]$  determines the ratio between the different types of penalization. In addition, the parameter  $\theta$  that determines the size of the penalty is defined. In the case when  $\alpha = 1$  the penalization is carried out in  $L_1$  space (LASSO regression); in the case when  $\alpha = 0$  penalization is carried out in  $L_2$  space (ridge regression). These models are constructed for each finite element separately.

## 2.3. Function Comparing Reconstructions

The physics of electrical capacitance tomography measurement is simple due to the lack of alternating current. The measurement is made using the charge-discharge method. Signal energy in ECT decreases with the square distance from the capacitor cover, so the measurement is best near the capacitor cover. Differently, an alternating current source for EIT measurement is applied to the transmitting electrode and the opposite receiving electrode during the measurement. Then, the potential difference (voltage) on the other adjacent electrodes is measured. In this case, the most incredible sensitivity occurs in the vicinity of the electrodes because the energy fluctuation of the electric field is greatest in these areas.

A reconstruction efficiency analysis was performed for both techniques in electrical tomography. In order to determine a more efficient reconstruction, the conductance value in each finite element was first transformed into a capacitance value. This transformation is written in Formula (4) using the function  $f(\cdot)$ . Then, for each finite element of the interior of the reconstructed object after all reconstructions, the minimum value of the parameter  $\gamma$  was determined according to equation (2). This parameter takes values in the range  $[0, 1]$ .

When this parameter takes a value  $\gamma < 0.5$ , the EIT reconstruction is considered to be a more efficient reconstruction.

When  $\gamma \geq 0.5$ , ECT reconstruction is considered more effective.

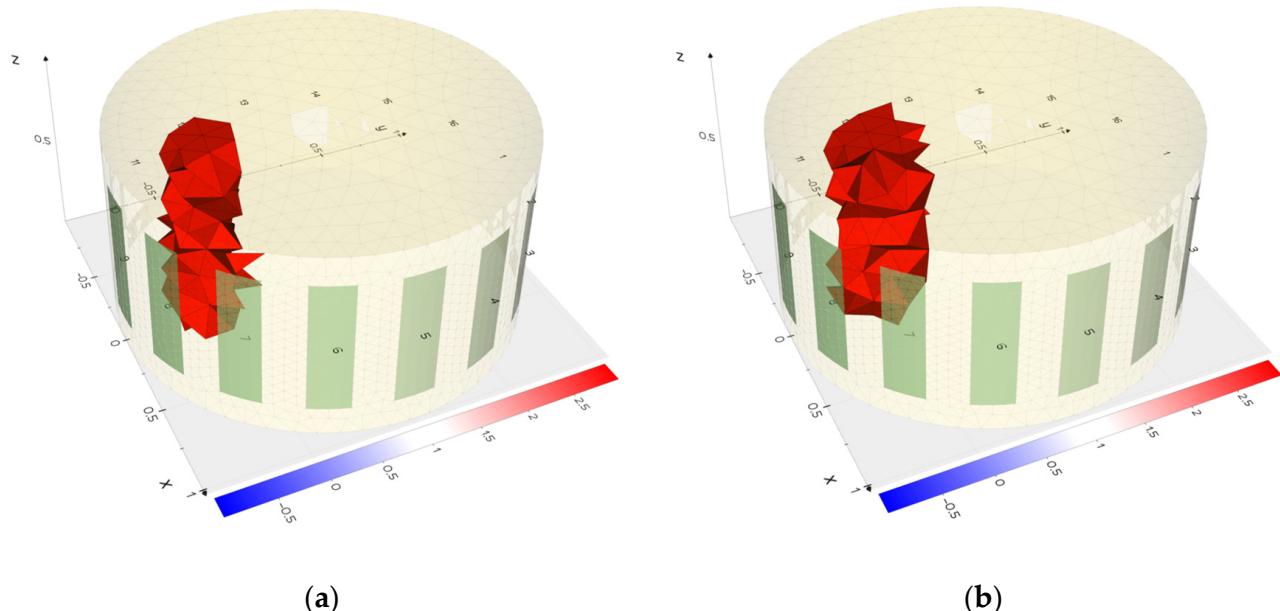
For each finite element  $e_j$ ,  $j = 1, \dots, 20,455$  consisting in minimizing the expression

$$\Psi(\gamma) = \min \|y_{ij} - \gamma x_{ij}^{ECT} \omega_{ij}^{ECT} - (1 - \gamma)f(x_{ij}^{EIT} \omega_{ij}^{EIT})\| \quad (4)$$

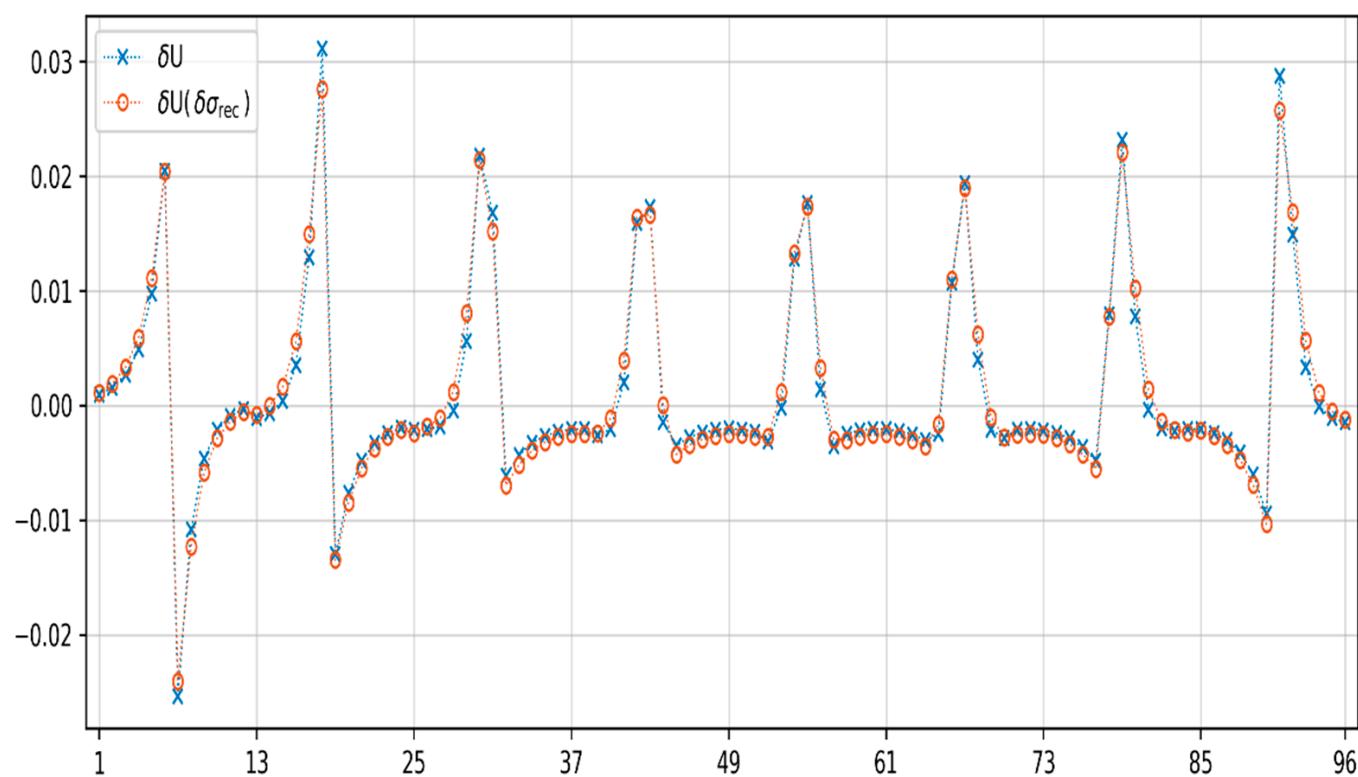
where,  $y_{ij}$ -value for finite element  $i$  for the  $j$ -th reconstruction,  $x_{ij}^{ECT}$ -ECT value for the  $j$ -th reconstruction,  $\omega_{ij}^{ECT}$ -coefficients in the elastic net model for the electrical capacitance tomography for the  $i$ -th finite element  $x_{ij}^{EIT}$ -EIT value for the  $j$ -th reconstruction,  $\omega_{ij}^{EIT}$ -coefficients in the elastic net model for the electrical impedance tomography for the  $i$ -th finite element.

### 3. Results and Discussion

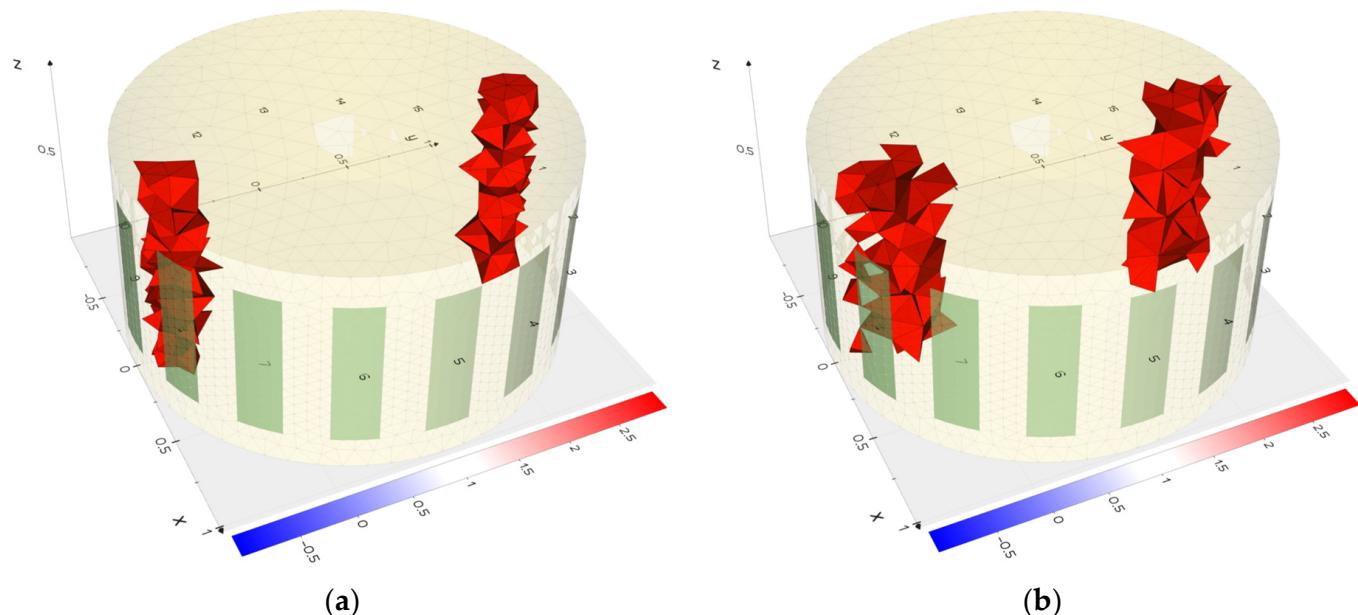
The first step was to train the elastic net model for both electrical tomography methods on 2000 randomly selected cases. Each of the 20,455 finite elements was trained separately. The parameters for which elastic net models were learned are  $\theta = 10^{-4}$  and  $\alpha = 0.3$ . Example reconstructions for one and three inclusions are shown for both methods. Example reconstructions for one and three inclusions are shown for both methods. Figure 5 shows the reconstruction for one inclusion and Figure 6 shows the impedance differences for EIT. Figure 7 shows the reconstruction for two inclusions and Figure 8 shows the impedance differences for the EIT measurements from Figure 7. Figure 9 shows the reconstruction for two inclusions but with a different inclusion position and Figure 10 shows the impedance differences for the EIT measurements from Figure 9. Figure 11 shows the reconstruction for one inclusion and Figure 12 shows the capacitance differences for ECT. Figure 13 shows the reconstruction for two inclusions, and Figure 14 shows the capacitance differences for the ECT measurements from Figure 13. Figure 15 shows the reconstruction for two inclusions but with a different inclusion position, and Figure 16 shows the capacitance differences for the ECT measurements from Figure 15. In addition, Figure 6, Figure 8, Figure 10, Figure 12, Figure 14, and Figure 16 show impedance differences for EIT, capacitance differences for ECT corresponding to the reference, and the measured values corresponding to the reconstructed case. Such a comparison allows one to see how far the measurements after reconstruction deviate from the reference. For comparison of distance values, the distances of the curves from Figure 6, Figure 8, Figure 10, Figure 12, Figure 14, and Figure 16 are shown in Tables 1 and 2.



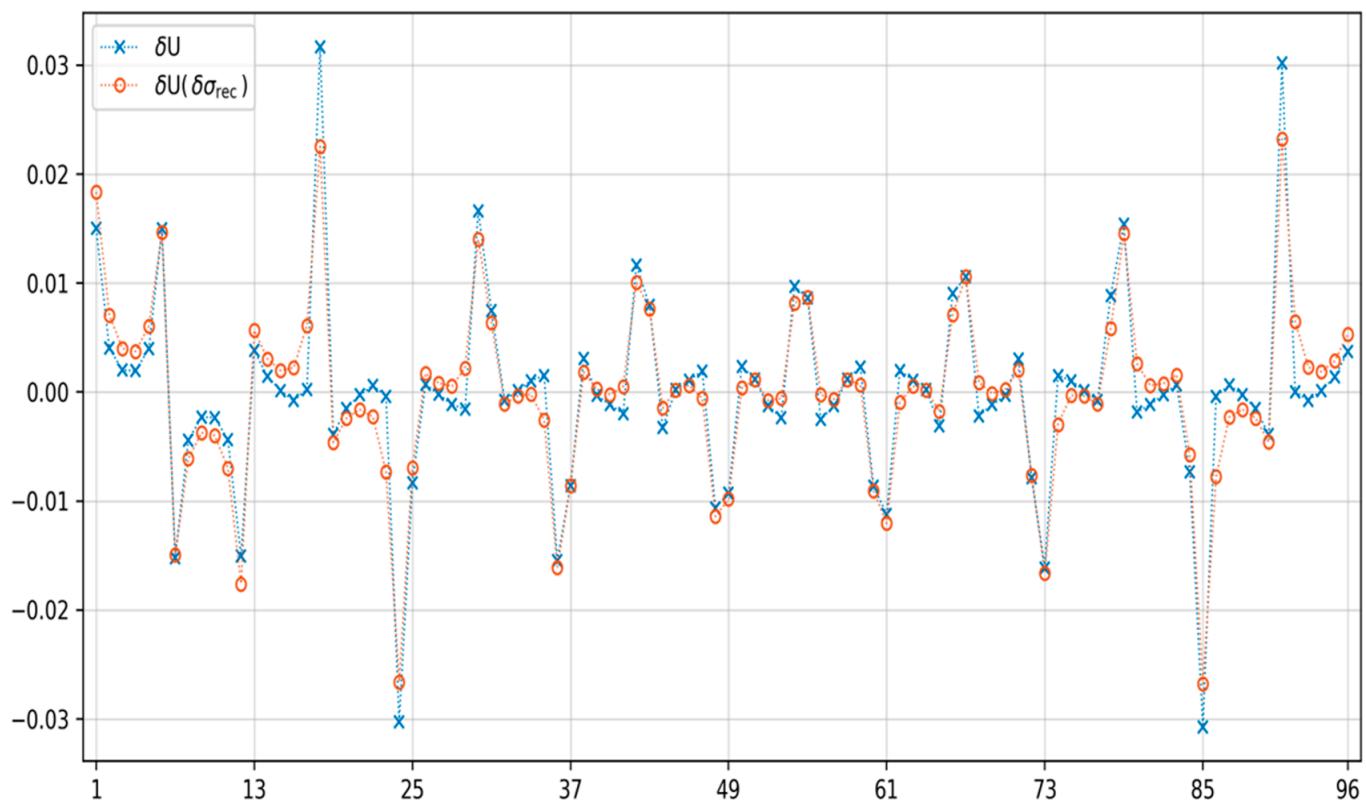
**Figure 5.** Comparison of the pattern (a) with reconstruction (b) in the field of view for one inclusion for EIT.



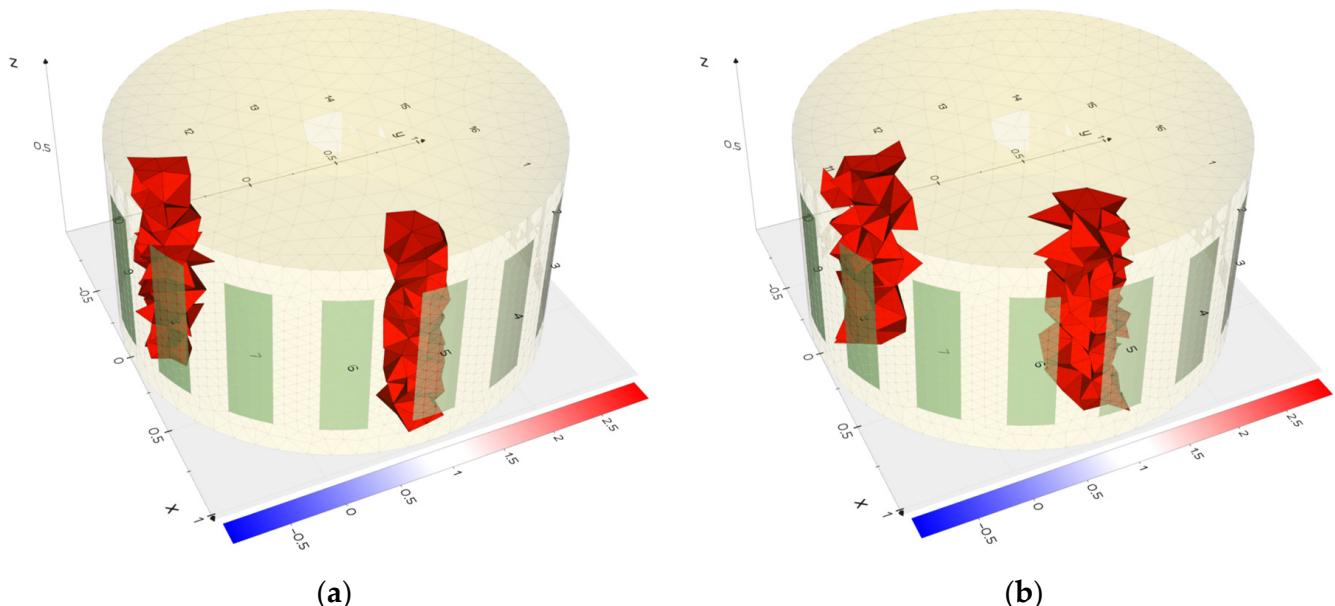
**Figure 6.** Comparison of electrode readings for Figure 5.



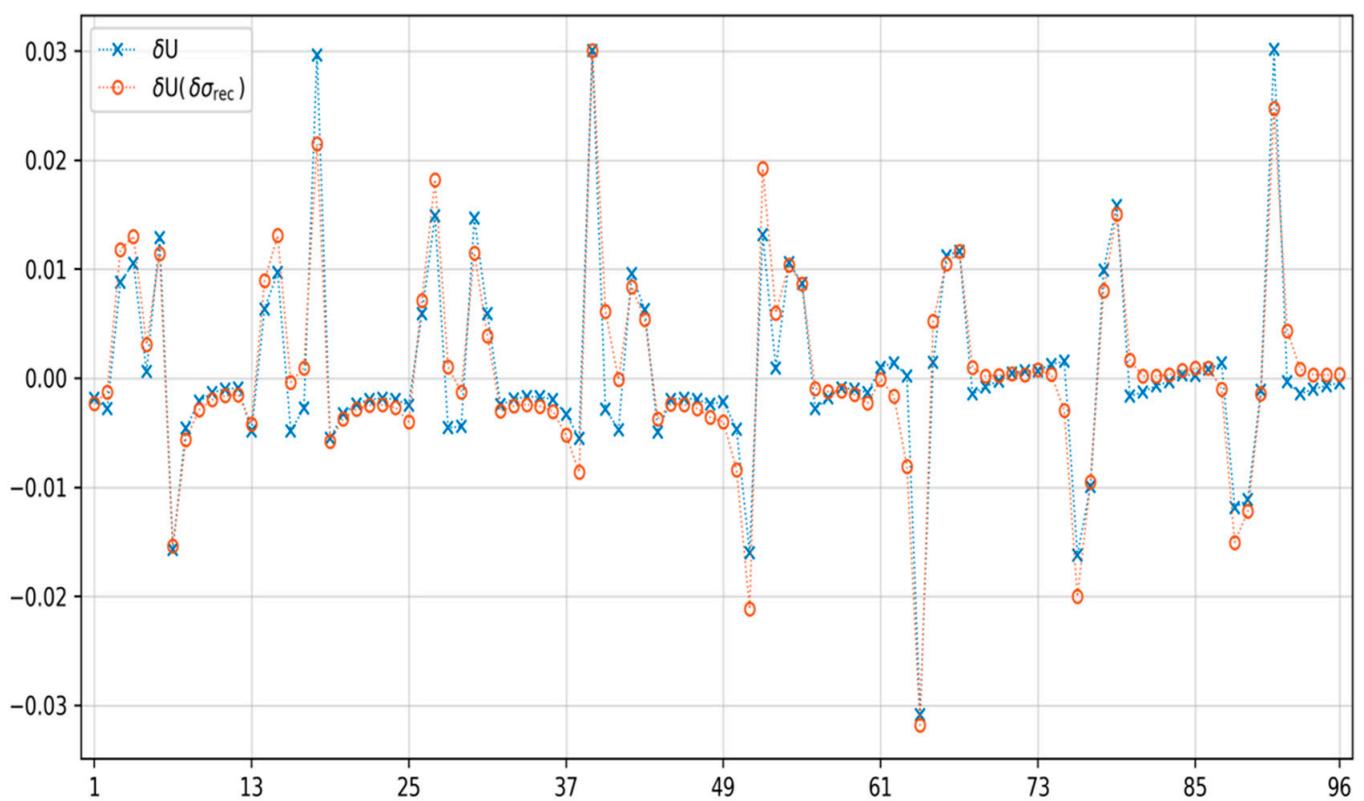
**Figure 7.** Comparison of the pattern (a) with reconstruction (b) in the field of view for one inclusion for EIT.



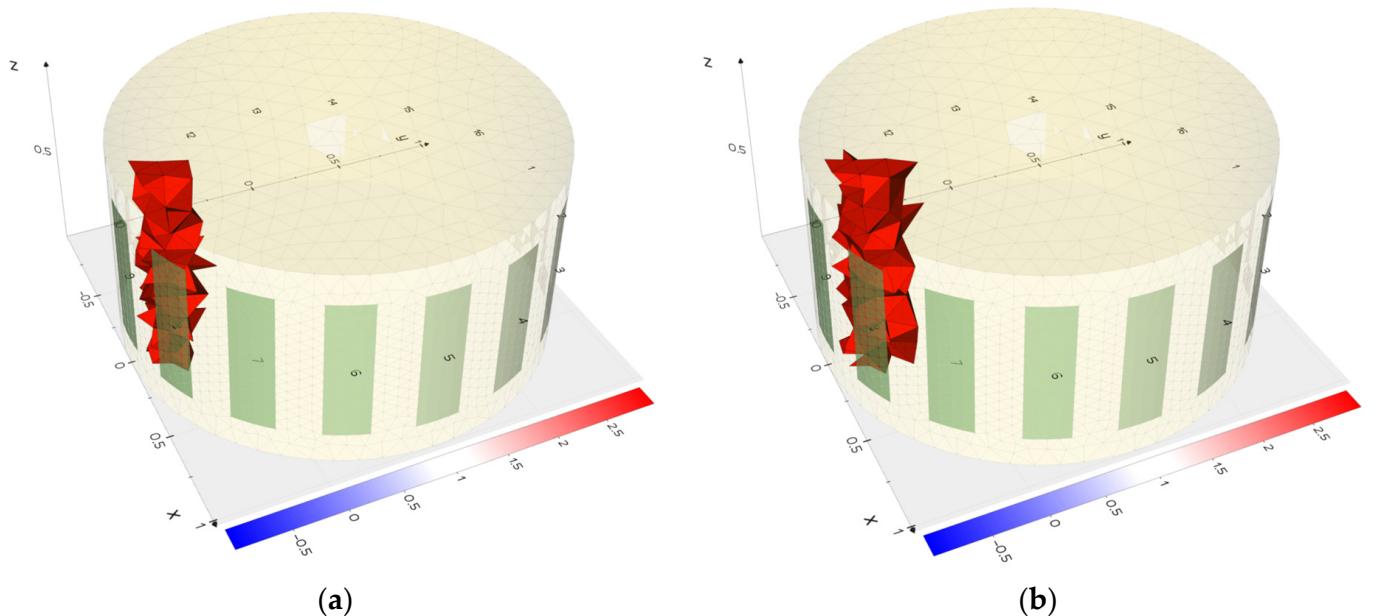
**Figure 8.** Comparison of electrode readings for Figure 7.



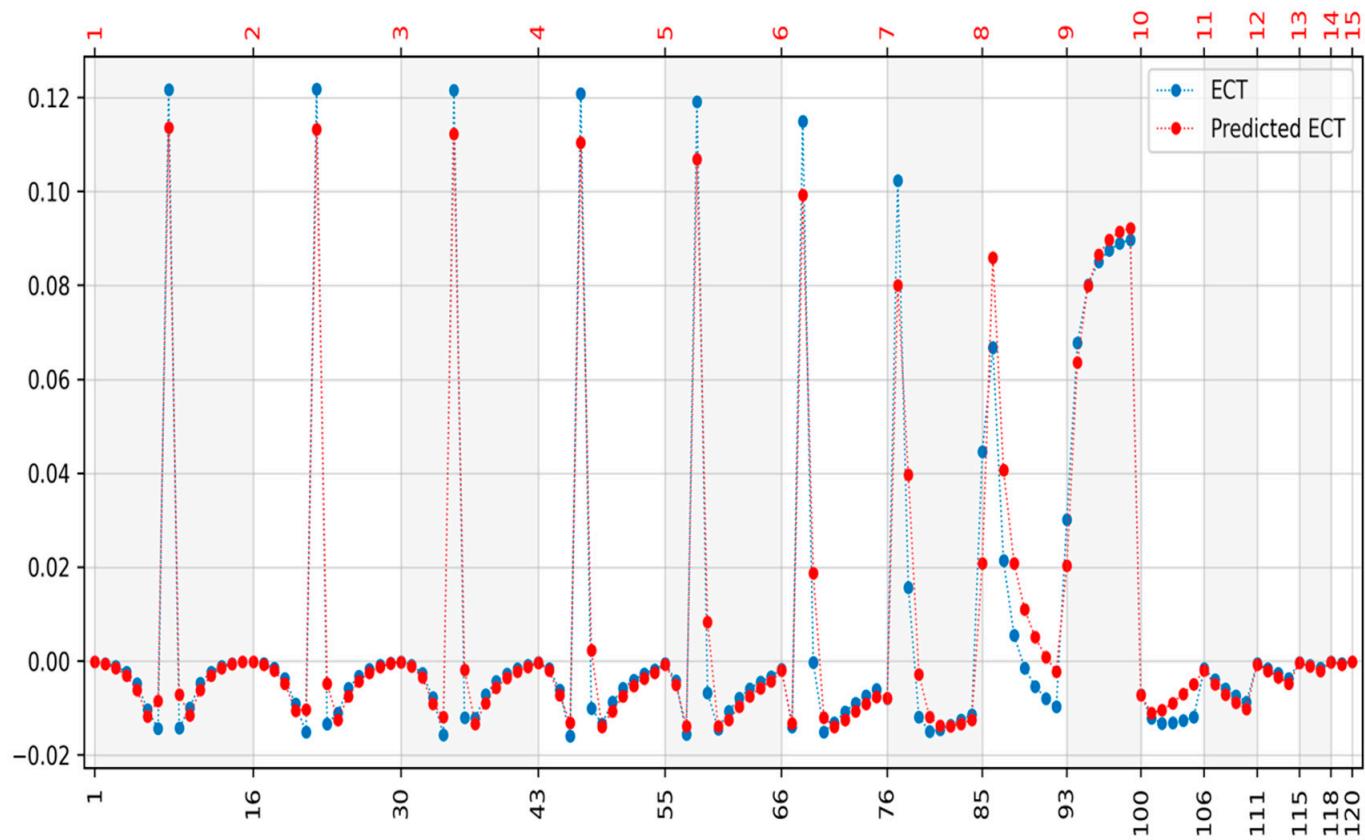
**Figure 9.** Comparison of the pattern (a) with reconstruction (b) in the field of view for three inclusions for EIT.



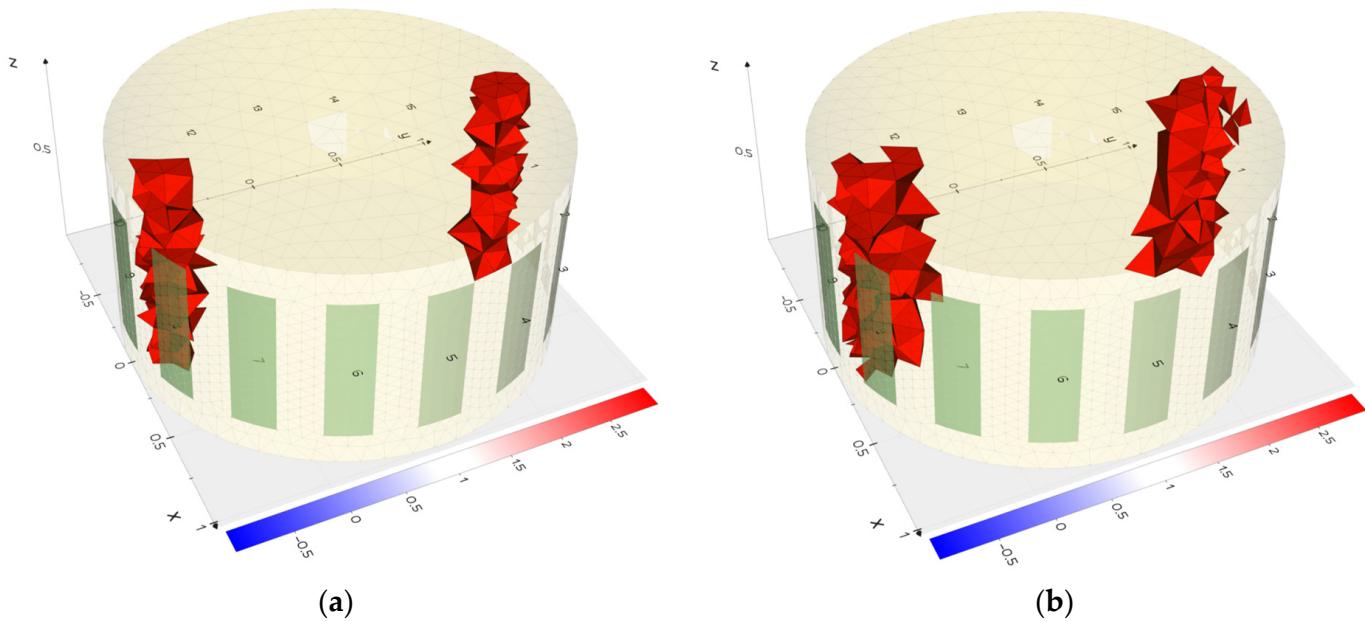
**Figure 10.** Comparison of electrode readings for Figure 9.



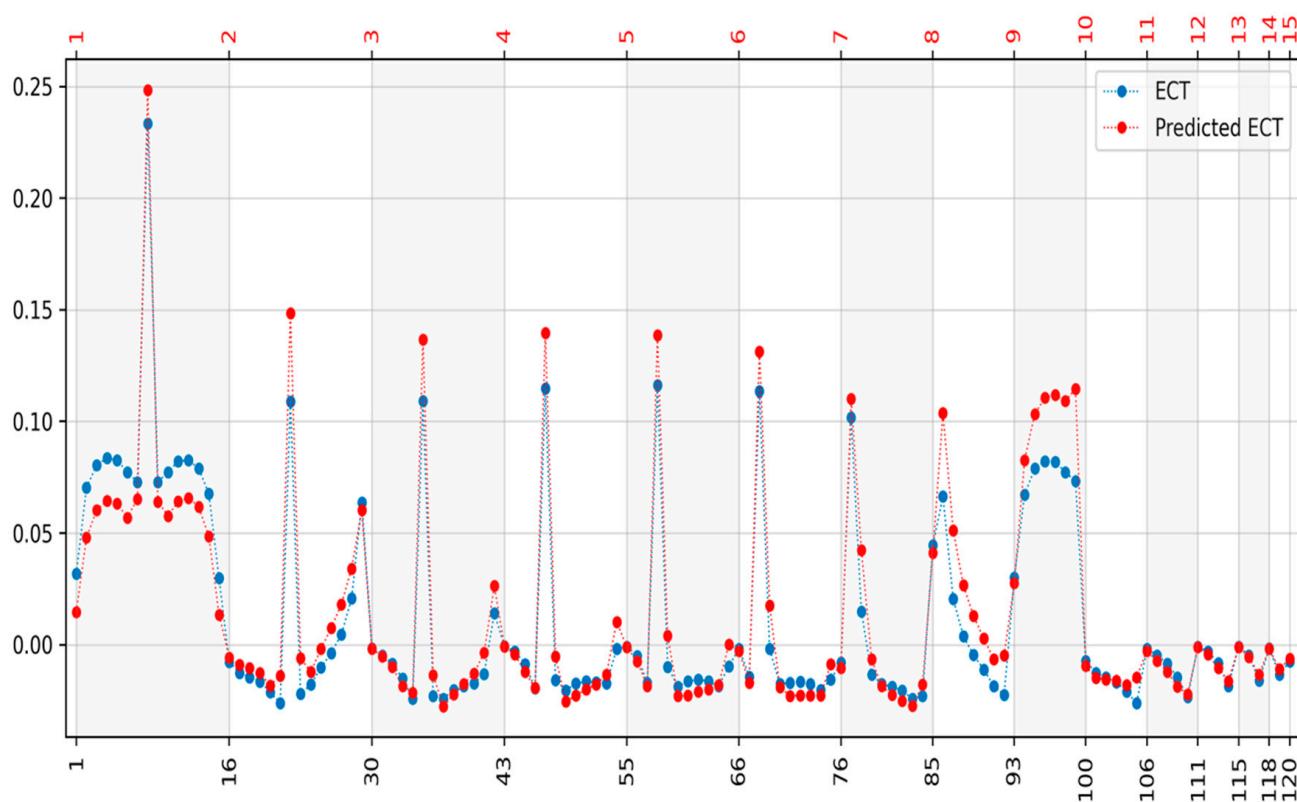
**Figure 11.** Comparison of the pattern (a) with the reconstruction (b) in the field of view for one inclusion for ECT.



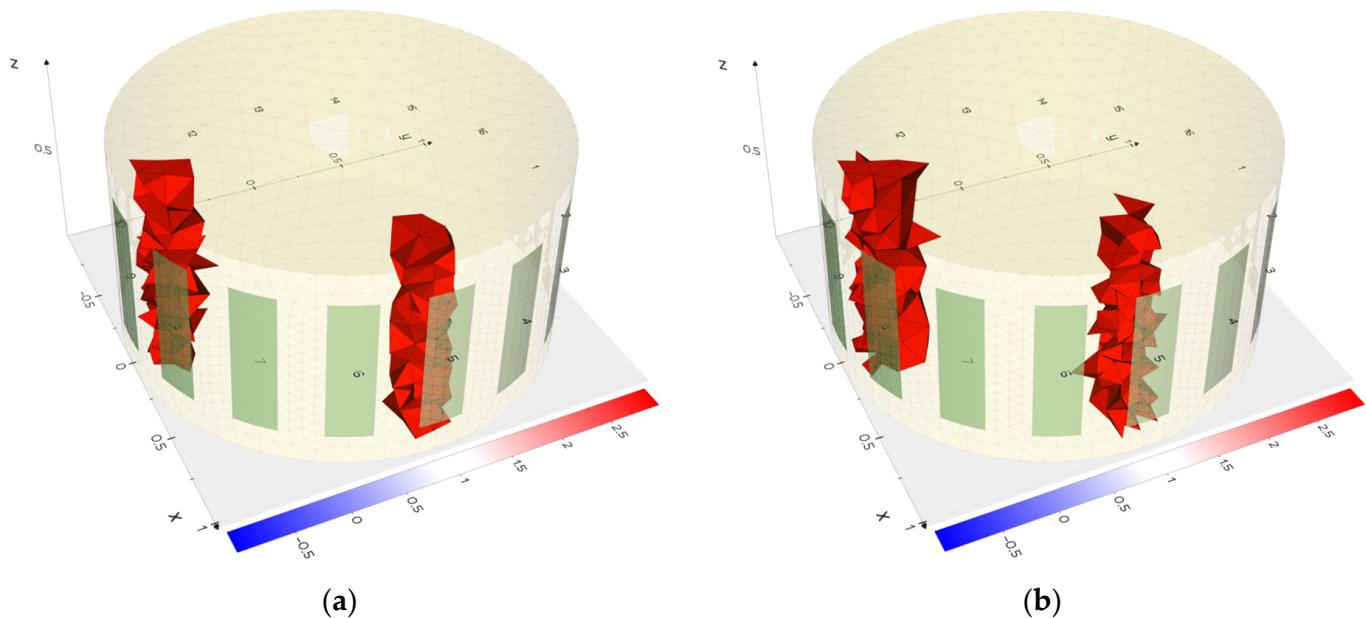
**Figure 12.** Comparison of electrode readings for Figure 11.



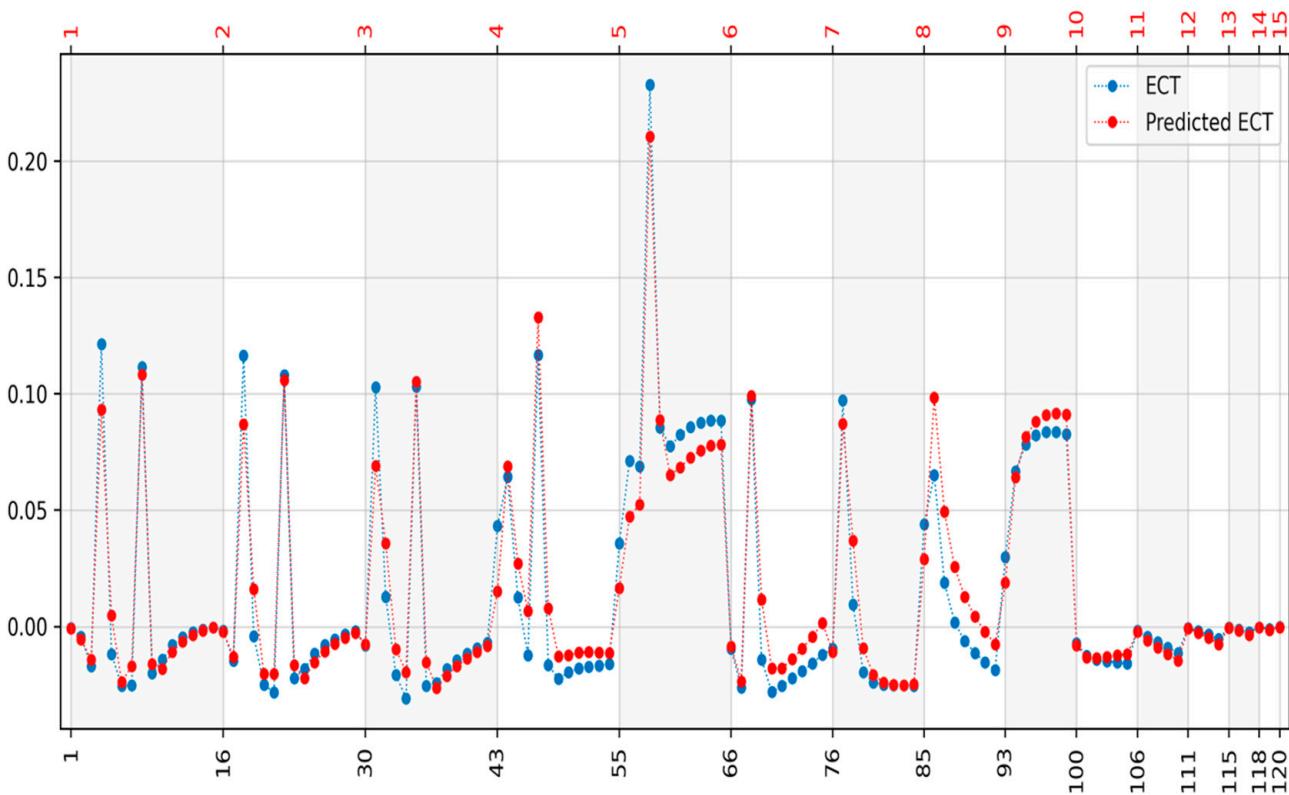
**Figure 13.** Comparison of the pattern (a) with the reconstruction (b) in the field of view for three inclusions for ECT.



**Figure 14.** Comparison of electrode readings for Figure 13.



**Figure 15.** Comparison of the pattern (a) with the reconstruction (b) in the field of view for three inclusions for ECT.



**Figure 16.** Comparison of electrode readings for Figure 15.

**Table 1.** Distances of original and reconstructed signal for EIT.

Example	RMSE	MAE	MAPE	SSIM	PSNR
1 (Figure 5)	0.001	0.001	21.083	0.999880	20.43792
2 (Figure 7)	0.003	0.002	33.736	0.998864	18.96357
3 (Figure 9)	0.003	0.002	33.784	0.998914	18.70378

**Table 2.** Distances of original and reconstructed signal for ECT.

Example	RMSE	MAE	MAPE	SSIM	PSNR
1 (Figure 11)	0.003	0.002	30.991	0.998586	17.97863
2 (Figure 13)	0.013	0.009	29.150	0.996790	16.64268
3 (Figure 15)	0.012	0.008	29.580	0.997954	16.87593

Given the value for the original signal  $O_i$ , value for the predicted signal (reconstruction)  $R_i$  for each element  $i = 1, \dots, n$ , the proposed distance measures are:

Root mean square error

$$RMSE = \sqrt{\frac{1}{n} \sum_{i=1}^n (O_i - R_i)^2} \quad (5)$$

Mean absolute error

$$MAE = \frac{1}{n} \sum_{i=1}^n |O_i - R_i| \quad (6)$$

Mean absolute percentage error

$$MAPE = \frac{100\%}{n} \sum_{i=1}^n \left| \frac{O_i - R_i}{O_i} \right| \quad (7)$$

Let  $I$  and  $RI$  be the original and reconstructed image, respectively. Thus,  $I(i,j)$  and  $RI(i,j)$  denote the values of  $(i,j)$  pixel ( $1 \leq i \leq m, 1 \leq j \leq n$ ) in the original and reconstructed image. To assess the reconstruction performance, we use the following measures.

Peak signal-to-noise ratio

$$PSNR = 10 \log_{10} \frac{nm(\max(I_{ij}, \max(RI_{ij}))^2}{\sum_{i=1}^m \sum_{j=1}^n (I_{ij} - RI_{ij})^2} \quad (8)$$

Structural similarity index measure

$$SSIM = \frac{(2\mu_I\mu_{RI} + c_1)(2\sigma_{I,RI} + c_2)}{(\mu_I^2 + \mu_{RI}^2 + c_1)(\sigma_I^2 + \sigma_{RI}^2 + c_2)} \quad (9)$$

where,  $\mu_I$ ,  $\mu_{RI}$ ,  $\sigma_I^2$  and  $\sigma_{RI}^2$  denote the pixel sample mean and variance of original  $I$  and reconstructed  $RI$  images,  $\sigma_{(I,RI)}$ —covariance of  $I$  and  $RI$ ,  $c_1$ ,  $c_2$ —some constants.

The above coefficients allow us to determine the distance of two signals. RMSE and MAE are similar coefficients. However, MAE, unlike RMSE, treats all distances equally. RMSE, due to the summation of differences of squares between distances, magnifies large differences between values. The MAPE coefficient expresses in percentage terms the relative differences to the value of the original signal.

### 3.1. Reconstruction EIT

For EIT reconstructions, individual inclusions, especially those close to the electrodes (Figure 5), are reconstructed better than those in the center (Figure 7). In the case of a larger number of inclusions when the inclusions are distant from each other, the obtained reconstructions of individual inclusions are clear. In the case of a larger number of inclusions placed close together, the reconstructions of the individual objects merge into a single area (Figure 9).

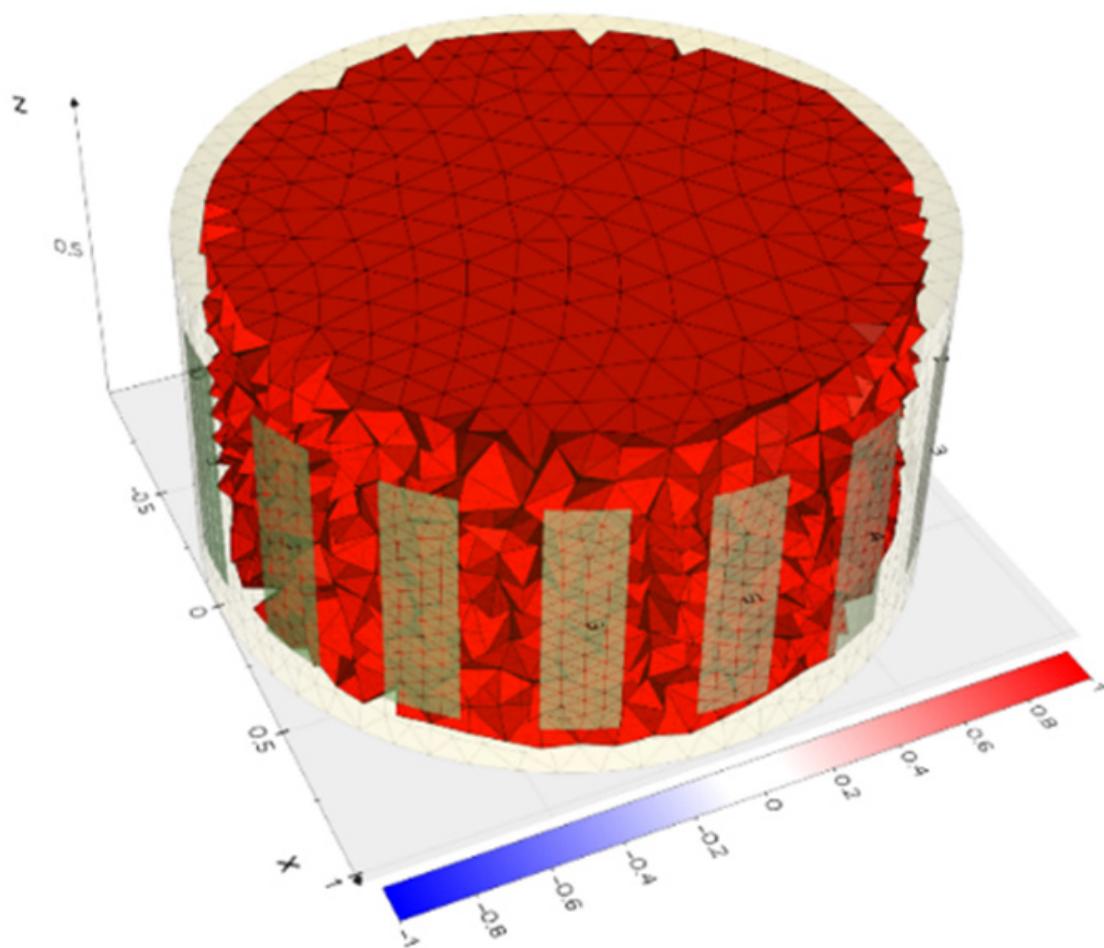
### 3.2. Reconstruction ECT

For reconstructions obtained with electrical capacitance tomography for multiple inclusions closer to the center of the study area, they are better reconstructed than with electrical impedance tomography. In contrast, the ECT method better reconstructs objects closer to the electrodes for single inclusions. Electrical capacitance tomography has more problems recognizing object boundaries closer to the center of the object's interior.

Based on the results, reconstruction efficiency parameters were calculated for each finite element according to Equation (2). Figure 17 shows the areas where one of the reconstruction methods is more effective. In the graph, the red color indicates areas better reconstructed by the ECT method, and the cream color indicates areas better reconstructed by the EIT method.

The results show that the area closer to the center of the reservoir is better reconstructed by electrical capacitance tomography, while the edges of the reservoir are more efficiently reconstructed by electrical impedance tomography. Furthermore, the percentage of finite elements with better efficiency of ECT compared to EIT is 65% to 35%.

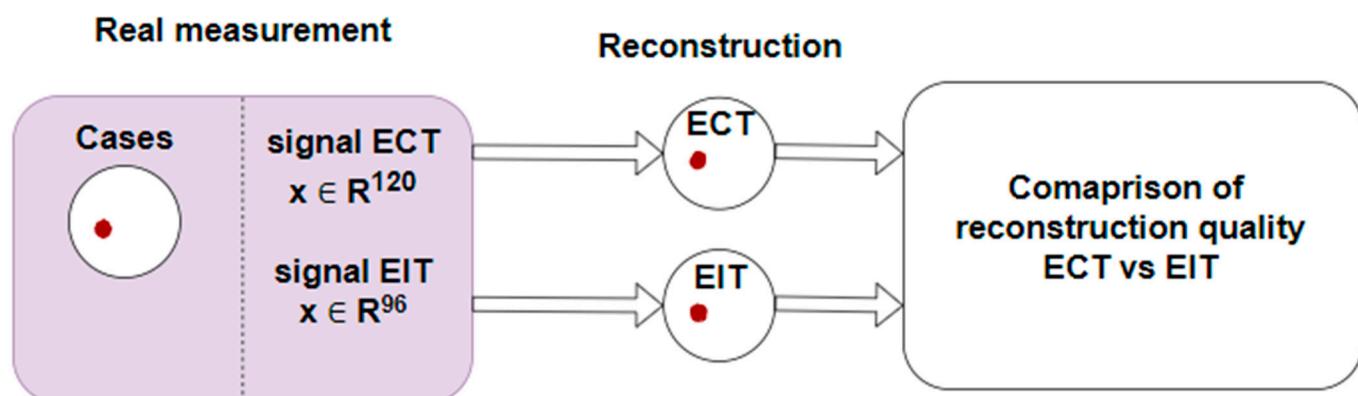
The simulations show that electrical impedance tomography gives better reconstruction quality near the reservoir edge than electrical capacitance tomography. Theoretically, it is because both methods better reconstruct objects closer to the edge of the tank. However, the fluctuation of signal energy closer to the edge of the tomography is more significant for electrical impedance tomography than electrical capacitance tomography, resulting in better reconstruction quality. In contrast, the situation is reversed for the ECT method.



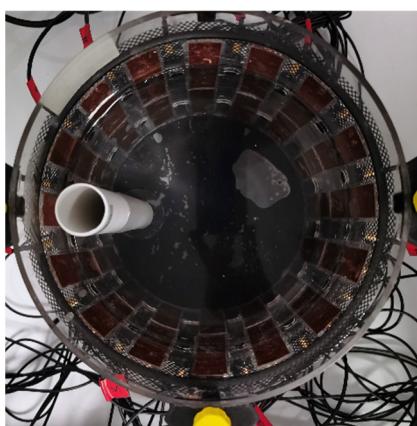
**Figure 17.** Areas of reconstruction highlight the effectiveness of methods.

### 3.3. Real Measurements

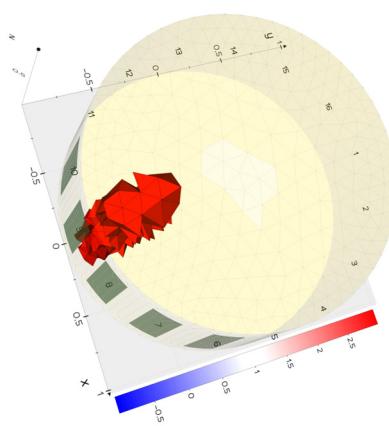
Real-world tests were conducted to verify the results of the simulation studies. Block diagram of the measurement method is presented in Figure 18. First, phantoms were placed in a tank to which electrodes were connected. Then, measurements were taken as in Figure 19a, Figure 20a, Figure 21a, Figure 22a and Figure 23a with EVT4 (Figure 3) and SmartEIT (Figure 2) devices. Next, reconstructions were made using the elastic net method with models learned from simulation data.



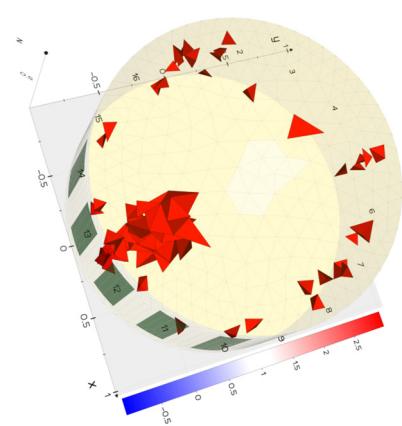
**Figure 18.** Block diagram of the measurement method for ECT and EIT.



(a)

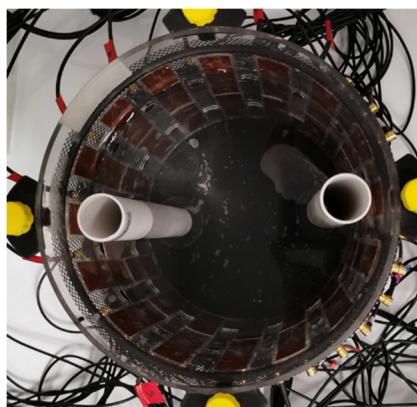


(b)

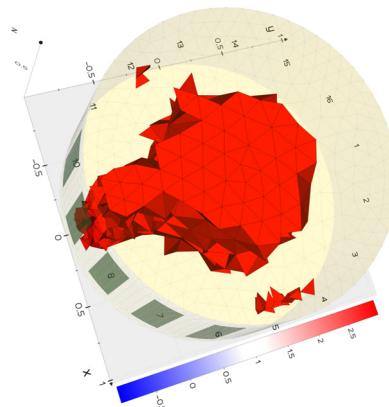


(c)

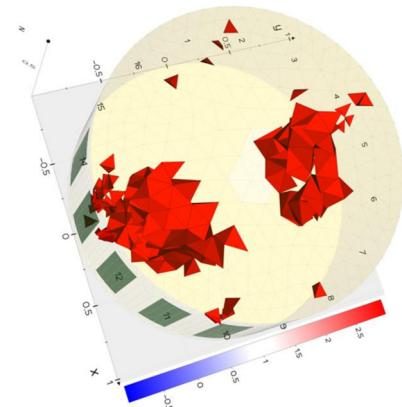
**Figure 19.** (a) Placing the measurement phantom in the tank, (b) image reconstruction based on EIT and (c) ECT tomography measurements.



(a)

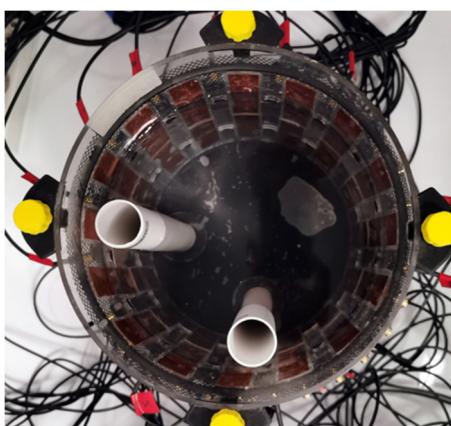


(b)

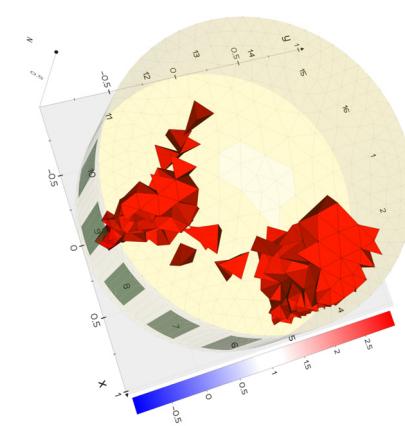


(c)

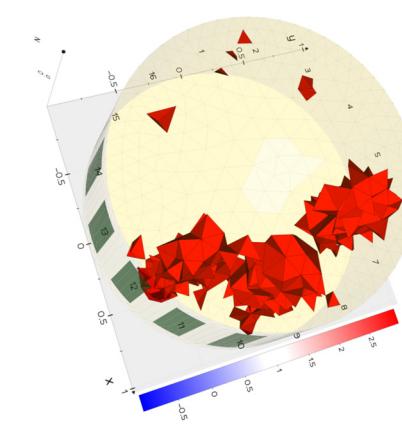
**Figure 20.** (a) Placement of measurement phantoms in the tank, (b) image reconstruction based on EIT, and (c) ECT tomography measurements.



(a)

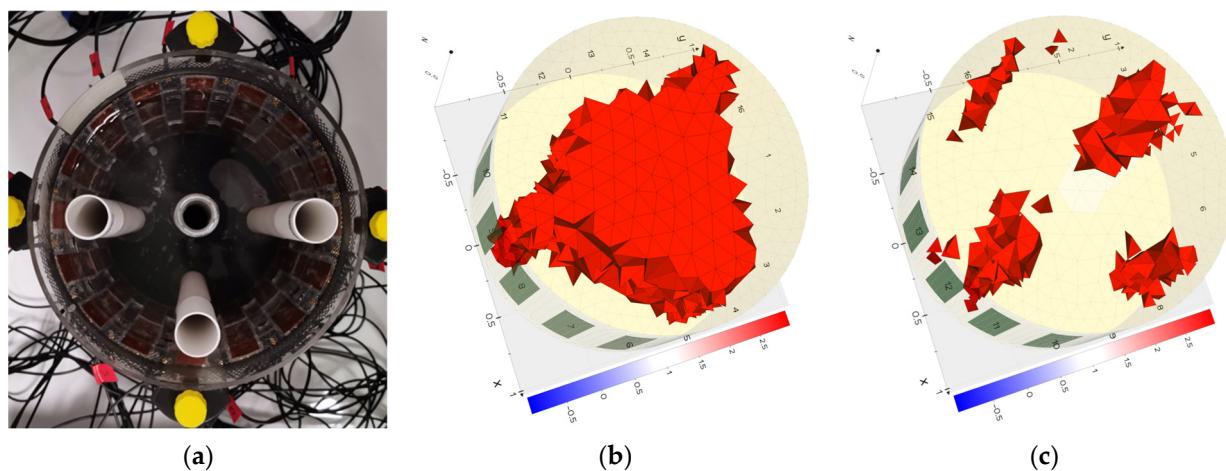


(b)

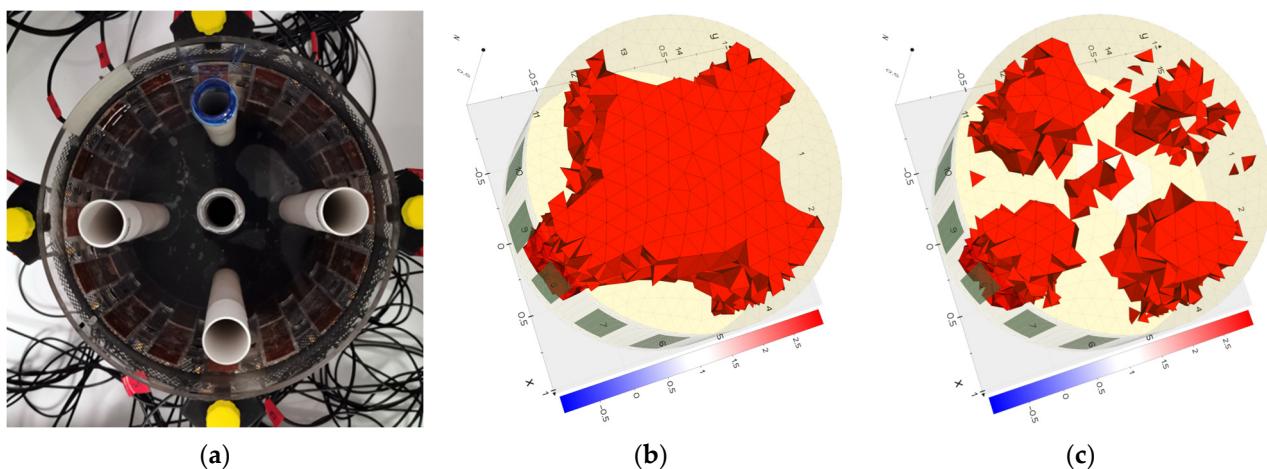


(c)

**Figure 21.** (a) Placement of measurement phantoms in the tank, (b) image reconstruction based on EIT and (c) ECT tomography measurements.



**Figure 22.** (a) Placement of measurement phantoms in the tank, (b) image reconstruction based on EIT, and (c) ECT tomography measurements.



**Figure 23.** (a) Placement of measurement phantoms in the tank, (b) image reconstruction based on EIT, and (c) ECT tomography measurements.

The results of the actual measurements confirm the conclusions obtained by comparing the reconstructions with the simulations. For example, in Figure 22a,b and Figure 23a,b, it can be observed that the centers of the reconstructed areas are blurred for electrical impedance tomography. In contrast, for electrical capacitance tomography, the inclusions within the center of the reservoir are reconstructed as distinct inclusion. Thus, inclusions in that area are better reconstructed by the ECT method than by EIT.

The results obtained with the paper were compared to those found in the literature. In the paper [59], the authors got the best results with the autoencoder. The error range was from 0.5976 for one element to 0.6601 for five elements.

In another of the papers [58], the authors use correlation coefficient (CC) and structural similarity (SS) as evaluation criteria, and the results are presented for RBFNN and HPSO-RBFNN networks. Better results were obtained for the RBFNN method and, depending on the number of elements, are 0.086 for SS two objects and 0.643 for CC, and, similarly for three objects, 0.047 and 0.365, respectively.

In the different paper [65], the authors obtained very good results for the LeNet solution and an absolute error ranging from 0.039 to 0.057.

Comparing this further with the results of paper [67] where the authors presented their achievements for the TSDL method, they obtained an RMSE error of  $8.7 \pm 0.8$  for one group of images and  $9.2 \pm 1.43$  for the other group of images containing lung phantoms.

#### 4. Conclusions

This paper presents the effectiveness of reconstruction by different methods in electrical tomography. The research was conducted on 5000 simulated inclusion cases. In the first step, the reconstruction algorithm was taught on a sample of randomly selected 2000 patterns using elastic net. Then, the remaining 3000 cases were reconstructed using the learned algorithm. The function defined by equation (2) was used in the next step. Finally, the areas that most efficiently reconstruct images from the measurement data were determined.

During training, the model was presented with cases with up to two inclusions. During the validation stage on actual measurement data, the model was effective for cases with more than two inclusions. However, for measurements with more than three inclusions, the predictions of central inclusions are worse than in other cases. This result is expected because inclusions near the edge of the tank “shield” the object and distort the electric field in the center of the tank, resulting in less information during measurement. In the next step, individual cases were reconstructed based on real measurements. Finally, based on the presented analysis, the results of the simulation studies were validated, confirming the results obtained earlier for the simulated data.

The results show that electrical capacitance tomography is better for areas closer to the center of the tank, where efficiency is about 65% of all finite elements. On the other hand, electrical impedance tomography gives better results for objects closer to the electrodes, which includes about 35% of all grid elements. These findings are directly related to the energy fluctuations for each method in different areas of the tank. Larger fluctuations in signal energy yield better reconstruction quality. For the EIT method, larger fluctuations in electric field energy than for the ECT method will occur at the edge of the reservoir. Similarly, in the center of the field of view, we will get larger fluctuations of electric field energy for capacitive electrical tomography; thus, this method gives the best results.

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